

Features

- High current capability
- Avalanche rated
- Low forward voltage drop
- High frequency operation

Description

This Schottky diode is suited for high frequency switch mode power supply.

Packaged in TO-220AB, TO-220AB narrow leads and I²PAK, this device is intended to be used in notebook, game station and desktop adapters, providing in these applications a good efficiency at both low and high load.

Figure 1. Electrical characteristics^(a)

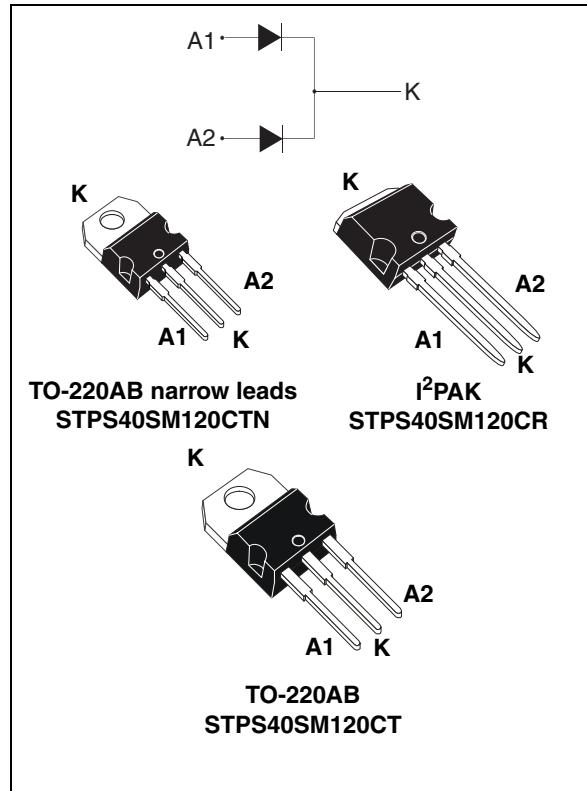
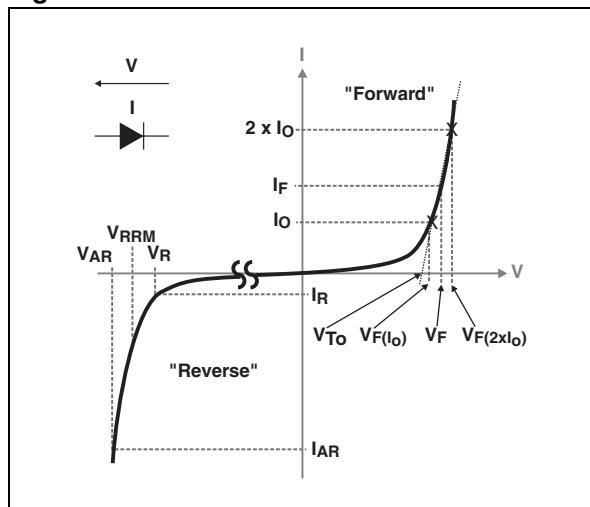


Table 1. Device summary

Symbol	Value
$I_{F(AV)}$	2 x 20 A
V_{RRM}	120 V
T_j (max)	150 °C
V_F (typ)	0.46 V

1 Characteristics

Table 2. Absolute ratings (limiting values per diode at $T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage			120	V
$I_{F(RMS)}$	Forward rms current			30	A
$I_{F(AV)}$	Average forward current, $\delta = 0.5$	Per diode	$T_c = 125^{\circ}\text{C}$	20	A
		Per device	$T_c = 115^{\circ}\text{C}$	40	
I_{FSM}	Surge non repetitive forward current	$t_p = 10\text{ ms sinusoidal}$		210	A
$P_{ARM}^{(1)}$	Repetitive peak avalanche power	$T_j = 125^{\circ}\text{C}$, $t_p = 10\text{ }\mu\text{s}$		1150	W
$V_{ARM}^{(2)}$	Maximum repetitive peak avalanche voltage	$t_p < 10\text{ }\mu\text{s}$, $T_j < 125^{\circ}\text{C}$, $I_{AR} < 7.7\text{ A}$		150	V
$V_{ASM}^{(2)}$	Maximum single-pulse peak avalanche voltage	$t_p < 10\text{ }\mu\text{s}$, $T_j < 125^{\circ}\text{C}$, $I_{AR} < 7.7\text{ A}$		150	V
T_{stg}	Storage temperature range			-65 to +175	$^{\circ}\text{C}$
T_j	Maximum operating junction temperature ⁽³⁾			150	$^{\circ}\text{C}$

- For pulse time duration deratings, please refer to [Figure 4](#). More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".
- See [Figure 9](#)
- $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case	Per diode	1.35	$^{\circ}\text{C/W}$
		Total	0.93	
$R_{th(c)}$	Coupling		0.50	

When the two diodes 1 and 2 are used simultaneously:

$$\Delta T_j(\text{diode 1}) = P(\text{diode 1}) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode 2}) \times R_{th(c)}$$

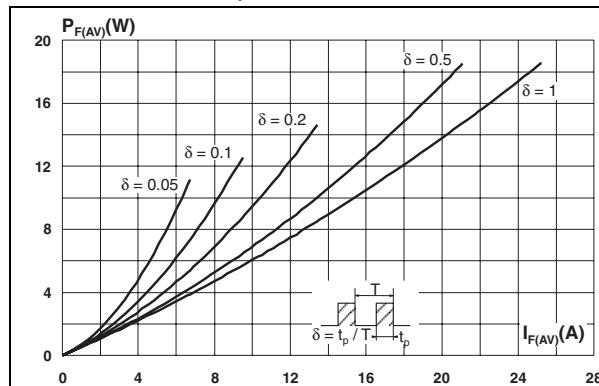
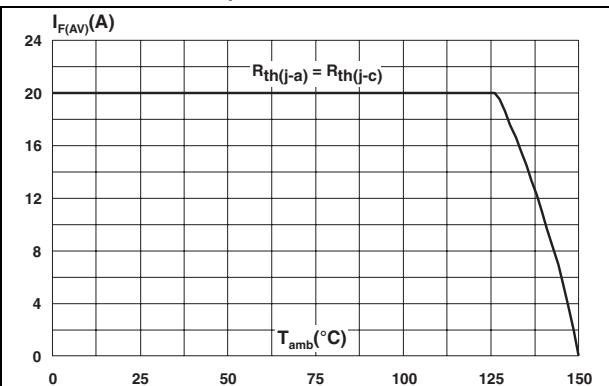
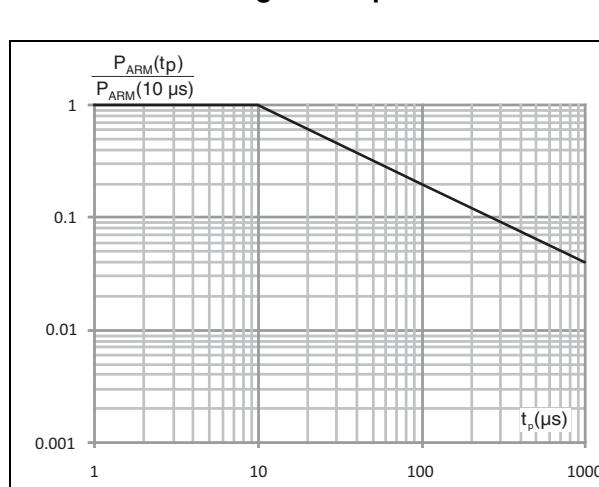
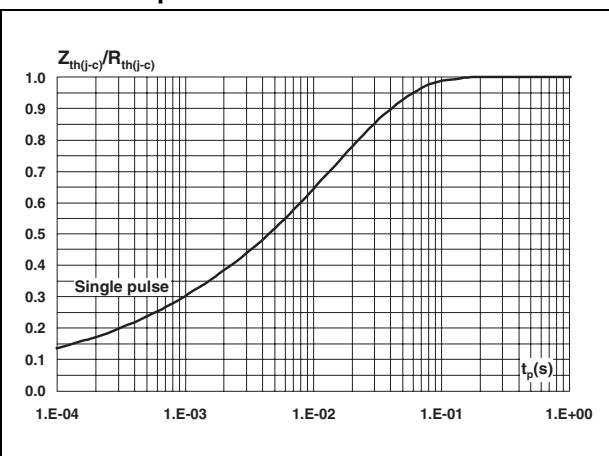
Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$	-	55	275	μA
		$T_j = 125^\circ\text{C}$		-	20	50	mA
$V_F^{(2)}$	Forward voltage drop	$T_j = 125^\circ\text{C}$	$I_F = 5 \text{ A}$	-	0.46	0.51	V
		$T_j = 125^\circ\text{C}$	$I_F = 10 \text{ A}$	-	0.55	0.60	
		$T_j = 25^\circ\text{C}$	$I_F = 20 \text{ A}$	-		0.83	
		$T_j = 125^\circ\text{C}$		-	0.63	0.69	

1. Pulse test: $t_p = 5 \text{ ms}$, $\delta < 2\%$ 2. Pulse test: $t_p = 380 \mu\text{s}$, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.52 \times I_{F(AV)} + 0.0085 \times I_F^2 (\text{RMS})$$

Figure 2. Average forward power dissipation versus average forward current (per diode)**Figure 3. Average forward current versus ambient temperature ($\delta = 0.5$, per diode)****Figure 4. Normalized avalanche power derating versus pulse duration****Figure 5. Relative variation of thermal impedance junction to case versus pulse duration**

3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS40SM120CTN	PS40SM120CTN	TO-220AB narrow leads	1.9 g	50	Tube
STPS40SM120CT	PS40SM120CT	TO-220AB	1.9 g	50	Tube
STPS40SM120CR	PS40SM120CR	I ² PAK	1.49 g	50	Tube